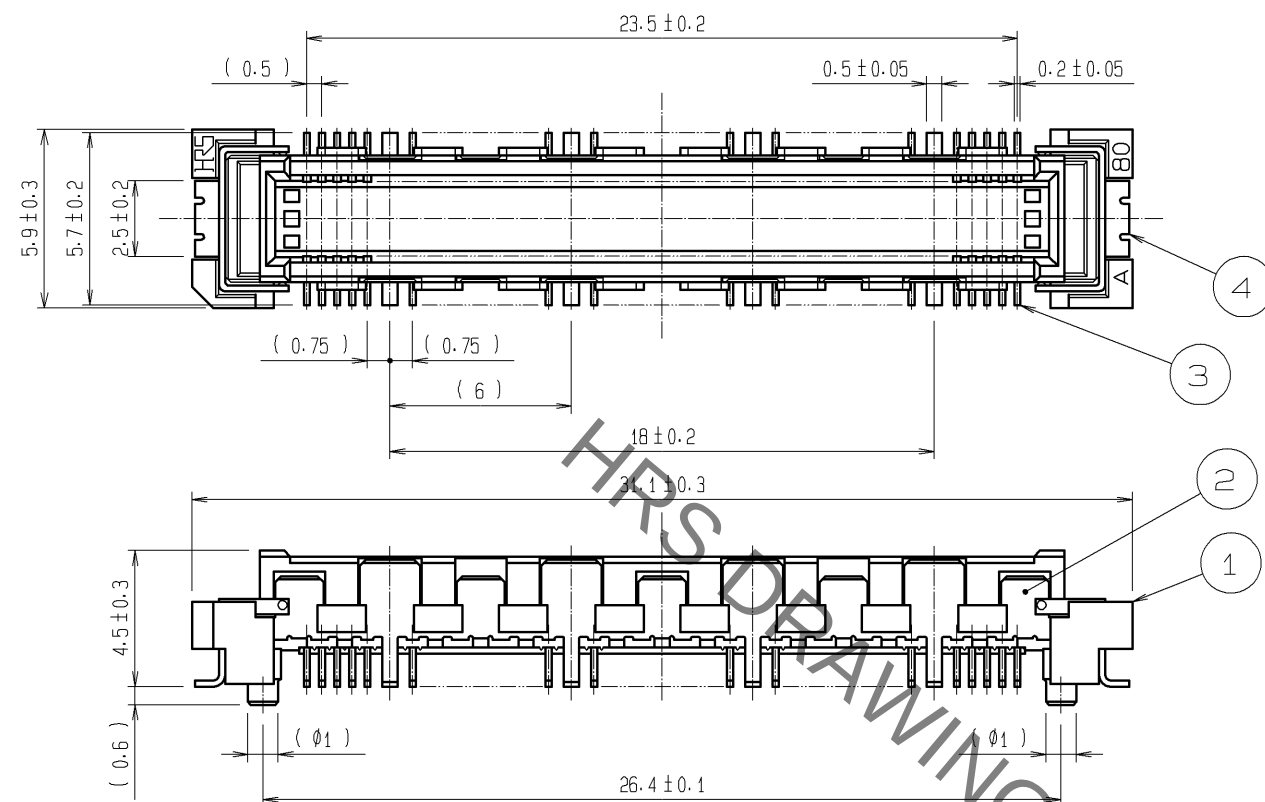
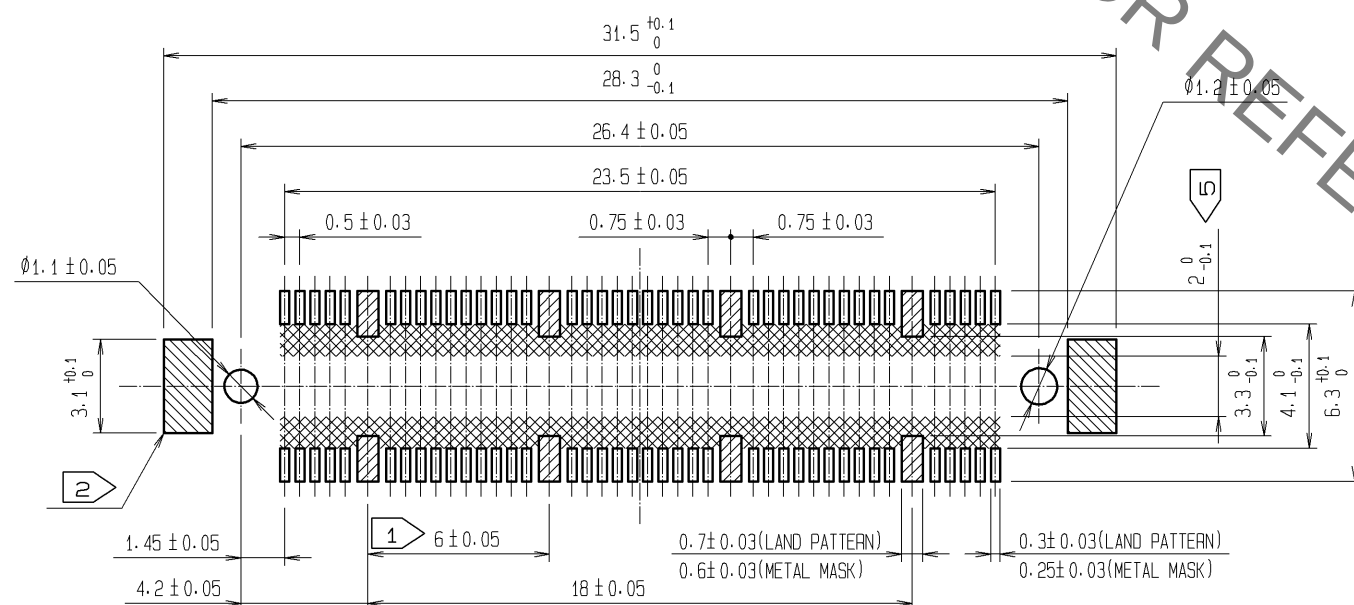


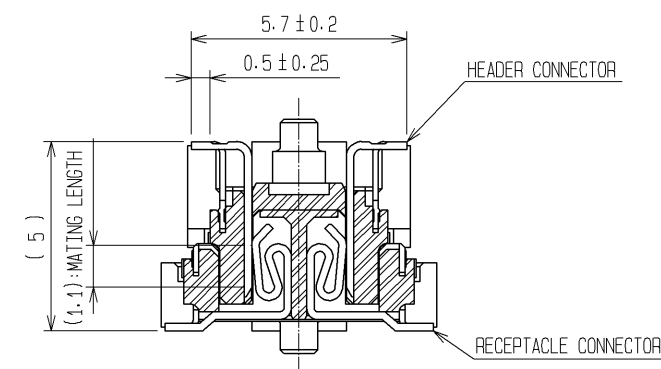


RECOMMENDED LAND PATTERN DIMENSION OF PCB
(RECOMMENDED METAL MASK THICKNESS: 0.15mm)

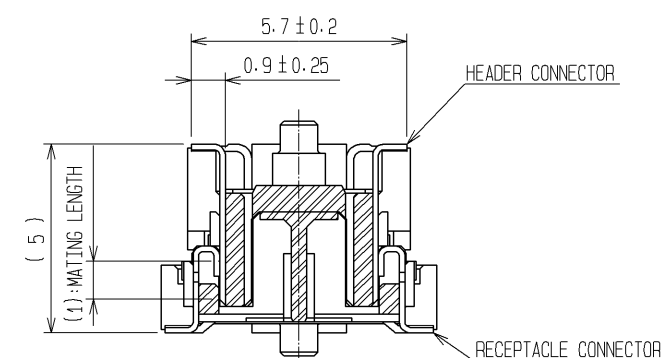


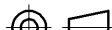
- NOTES
- 1 8 HATCHED PARTS: GROUND CIRCUIT.
 - 2 2 HATCHED PARTS: GROUND CIRCUIT.
 - 3 SMT LEAD-COPLANARITY: 0.1 MAX.
 - 4 THIS PRODUCT HAS NO POLARITY TO PATTERN FOR MOUNTING.
 - 5 MAKE SURE WIDTH OF PATTERN IS WITHIN THAT OF LAND, OR LEAD MAY TOUCH PATTERN. (THIS APPLIES TO HATCHED AREA.)
 - 6 THE DIMENSIONS IN PARENTHESES ARE FOR REFERENCE.

CROSS CUT SECTION - SIGNAL (5:1)



CROSS CUT SECTION - GROUND (5:1)



2	PHOSPHOR BRONZE	TIN-PLATING	3	PHOSPHOR BRONZE	CONTACT AREA : GOLD 0.1μm min.					
1	LCP	BEIGE UL94V-0			LEAD AREA : TIN-PLATING 1μm min.					
					UNDER PLATING : NICKEL 1μm min.					
NO.	MATERIAL	FINISH, REMARKS		NO.	MATERIAL	FINISH, REMARKS				
UNITS mm			SCALE 4 : 1		COUNT	DESCRIPTION OF REVISIONS		DESIGNED	CHECKED	DATE
 HIROSE ELECTRIC CO., LTD.			APPROVED : HS. OKAWA		08.06.26	DRAWING NO. EDC3-151960-25				
			CHECED : HT. YAMAGUCHI		08.06.25	PART NO. FX10A-80P/8-SV1(71)				
			DESIGNED : SY. KAMIGA		08.06.23	CODE NO. CL570-0101-0-71				
			DRAWN : HK. SUNADORI		08.06.17	 1/				